



ALPHA & OMEGA
SEMICONDUCTOR

AO3418

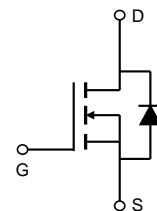
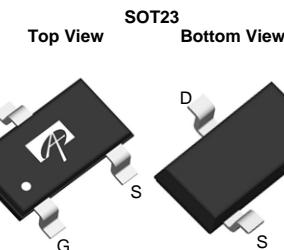
30V N-Channel MOSFET

General Description

The AO3418 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

Product Summary

| | |
|-----------------------------------|--------|
| V_{DS} | 30V |
| I_D (at $V_{GS}=10V$) | 3.8A |
| $R_{DS(ON)}$ (at $V_{GS}=10V$) | < 55mΩ |
| $R_{DS(ON)}$ (at $V_{GS} =4.5V$) | < 65mΩ |
| $R_{DS(ON)}$ (at $V_{GS} =2.5V$) | < 85mΩ |



Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|----------------------------------------|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | 30 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | V |
| Continuous Drain Current | I_D | 3.8 | A |
| $T_A=70^\circ C$ | | 3.1 | |
| Pulsed Drain Current ^C | I_{DM} | 15 | |
| $T_A=25^\circ C$ | P_D | 1.4 | W |
| $T_A=70^\circ C$ | | 0.9 | |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Units |
|---------------------------------------------------------|-----------------|-----------------|-----|-------|
| Maximum Junction-to-Ambient ^A $t \leq 10s$ | $R_{\theta JA}$ | 70 | 90 | °C/W |
| Maximum Junction-to-Ambient ^{A,D} Steady-State | | 100 | 125 | °C/W |
| Maximum Junction-to-Lead | Steady-State | $R_{\theta JL}$ | 63 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|---------------------------------------|--------------------------------------------------------------------------------|------|------|-----------|------------------|
| STATIC PARAMETERS | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D=250\mu\text{A}, V_{GS}=0\text{V}$ | 30 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=30\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$ | | | 1 | μA |
| I_{GSS} | Gate-Body leakage current | $V_{DS}=0\text{V}, V_{GS}=\pm 12\text{V}$ | | | ± 100 | nA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}, I_D=250\mu\text{A}$ | 0.5 | 1 | 1.5 | V |
| $I_{\text{D(ON)}}$ | On state drain current | $V_{GS}=10\text{V}, V_{DS}=5\text{V}$ | 15 | | | A |
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{GS}=10\text{V}, I_D=3.8\text{A}$ $T_J=125^\circ\text{C}$ | 43 | 55 | | $\text{m}\Omega$ |
| | | $V_{GS}=4.5\text{V}, I_D=3.5\text{A}$ | 70 | 84 | | $\text{m}\Omega$ |
| | | $V_{GS}=2.5\text{V}, I_D=1\text{A}$ | 47 | 65 | | $\text{m}\Omega$ |
| g_{FS} | Forward Transconductance | $V_{DS}=5\text{V}, I_D=3.8\text{A}$ | 59 | 85 | | $\text{m}\Omega$ |
| V_{SD} | Diode Forward Voltage | $I_S=1\text{A}, V_{GS}=0\text{V}$ | 1.4 | | | S |
| I_S | Maximum Body-Diode Continuous Current | | 0.75 | 1 | 1.5 | V |
| DYNAMIC PARAMETERS | | | | | | |
| C_{iss} | Input Capacitance | $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$ | 185 | 235 | 285 | pF |
| C_{oss} | Output Capacitance | | 25 | 35 | 45 | pF |
| C_{rss} | Reverse Transfer Capacitance | | 10 | 18 | 25 | pF |
| R_g | Gate resistance | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$ | 2.1 | 4.3 | 6.5 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| $Q_g(10\text{V})$ | Total Gate Charge | $V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=3.8\text{A}$ | | 10 | 12 | nC |
| $Q_g(4.5\text{V})$ | Total Gate Charge | | | 4.7 | | nC |
| Q_{gs} | Gate Source Charge | | | 0.95 | | nC |
| Q_{gd} | Gate Drain Charge | | | 1.6 | | nC |
| $t_{\text{D(on)}}$ | Turn-On Delay Time | $V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=3.95\Omega, R_{\text{GEN}}=3\Omega$ | 3.5 | | | ns |
| t_r | Turn-On Rise Time | | 1.5 | | | ns |
| $t_{\text{D(off)}}$ | Turn-Off Delay Time | | 17.5 | | | ns |
| t_f | Turn-Off Fall Time | | 2.5 | | | ns |
| t_{rr} | Body Diode Reverse Recovery Time | $I_F=3.8\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | 8.5 | 11 | | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | $I_F=3.8\text{A}, dI/dt=100\text{A}/\mu\text{s}$ | 2.6 | 3.5 | | nC |

A. The value of R_{JJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{ C}$. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{ C}$, using $\leq 10\text{s}$ junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{ C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{ C}$.

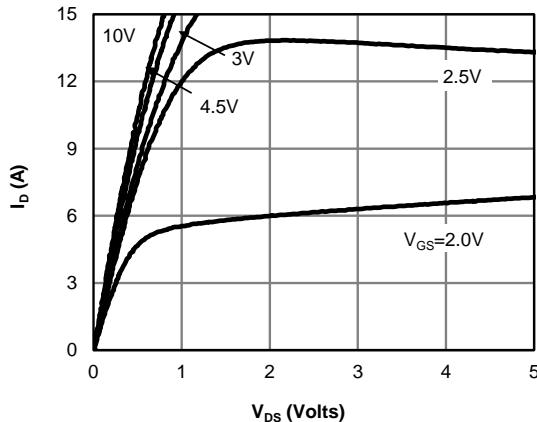
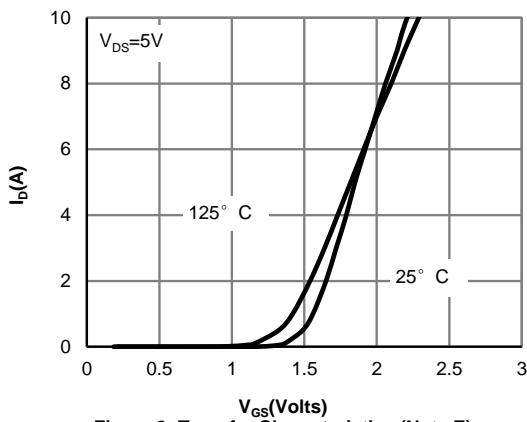
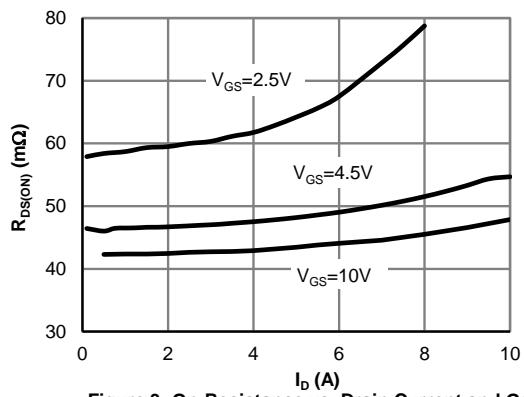
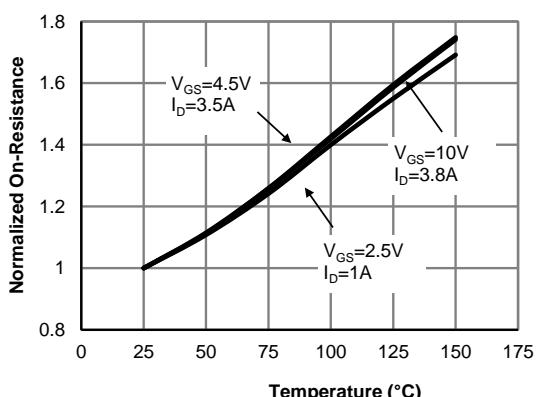
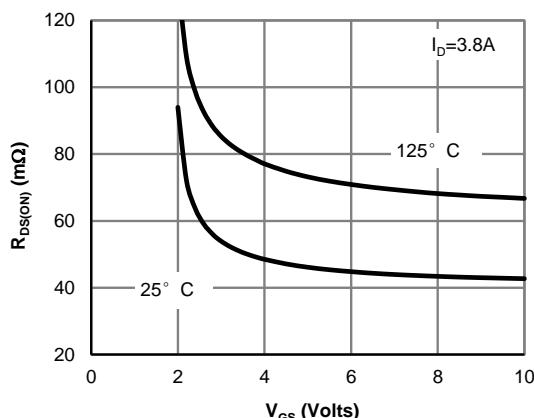
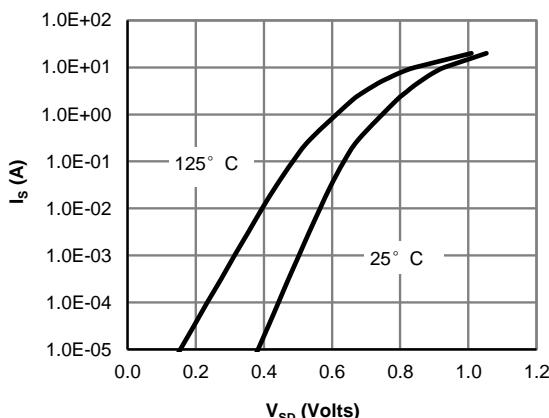
D. The R_{JJA} is the sum of the thermal impedance from junction to lead R_{JL} and lead to ambient.

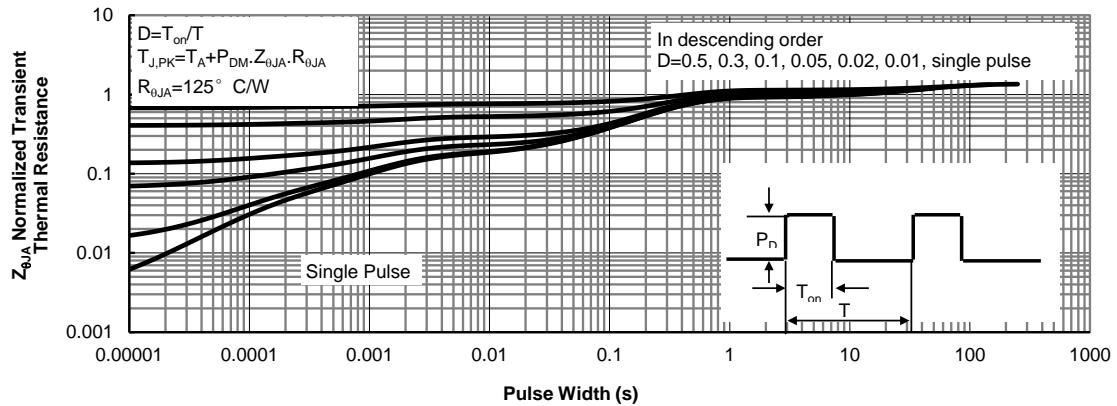
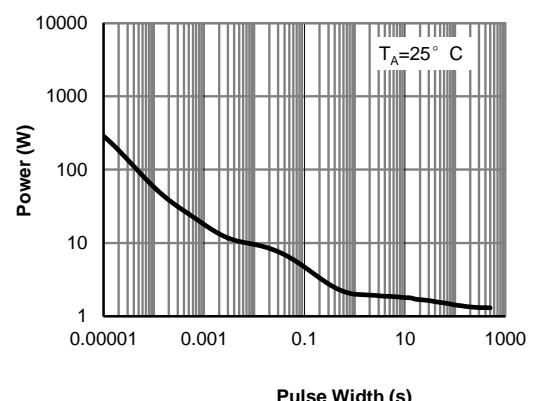
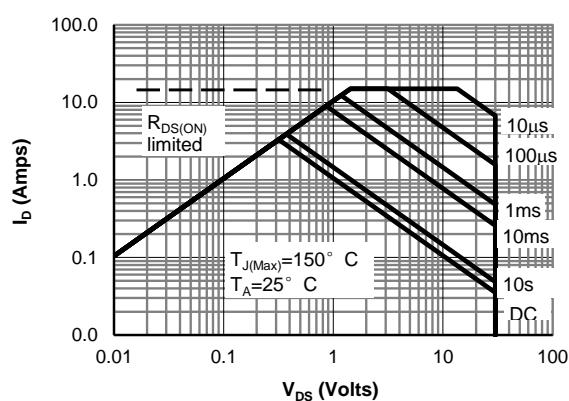
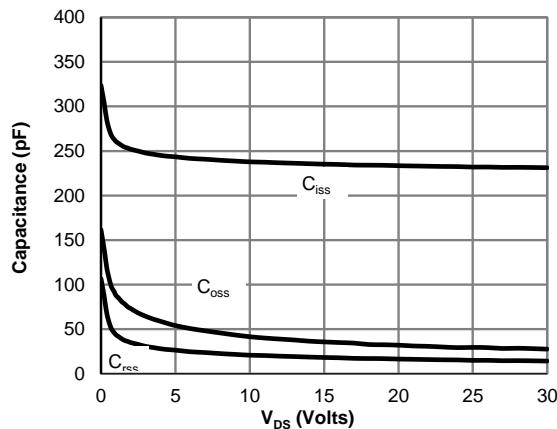
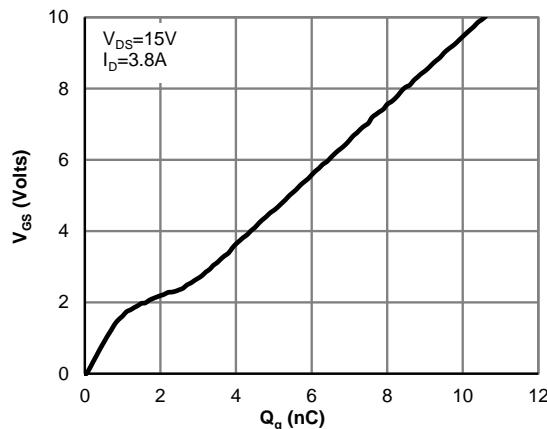
E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

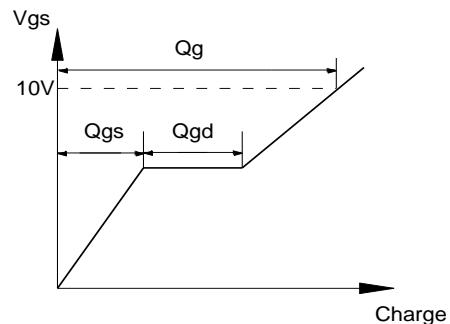
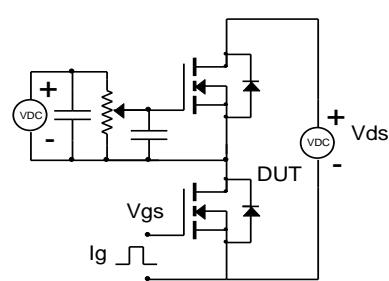
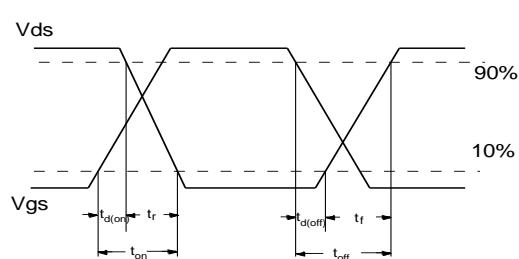
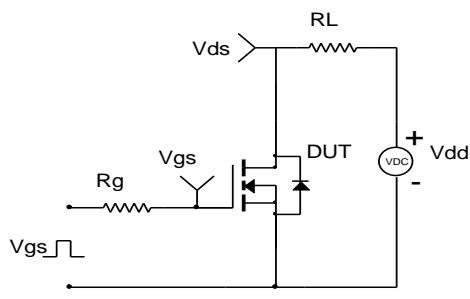
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{ C}$. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
